MULTI-COM.PL



HP Silicone Thermal Conductive Paste 5000 g - Plastic Bucket

Product ID: 23459

Price: 212.00 EUR

Product weight: 5.00 kg

Description:

HP Silicone Thermal Conductive Paste 5000 g - Plastic Bucket

HP silicone paste is a thermal conductive preparation with a thermal conductivity of 1.5 W/mK, designed for efficient heat dissipation from electronic components. The product is characterized by its white color and a density of 2.1 g/cm? at 20°C. The substance maintains its operating properties over a wide temperature range from -50°C to 250°C. The preparation does not conduct electricity, which eliminates the risk of electrical damage, and demonstrates resistance to the effects of acids, bases, salts, sulfur dioxide, and ammonia.

Go to the product

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